

DOCKET NO.: HSJ920050087US1**Recordation Form Cover Sheet
PATENTS ONLY**

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
(1) Timothy Clark Reiley
(2) Nicholas Buchan
2. Name and address of receiving party(ies):
Name: **Hitachi Global Storage Technologies
Netherlands B.V.**

Street Address:
**Locatellikade 1
1076 AZ Amsterdam
P.O. Box 75215
1070 AE Amsterdam
The Netherlands**

Additional name(s) of conveying
party(ies) attached ☐ Yes ☒ No

Additional name(s) & address(es) attached?
☐ Yes ☒ No

3. Nature of conveyance: ☒ Assignment
Execution Date: (1) October 4, 2005 (2) October 10, 2005

4. Application number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)
11/329,930 filed January 10, 2006

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom
correspondence concerning document
should be mailed:

Name: **Hitachi Global Storage Technologies
Internal**
Address: **Intellectual Property Law
Street**
Address: **5600 Cottle Road, Dept. NHGB/014-2,
San Jose, California 95193**

6. Total Number of applications and
patents involved: **One**


7. Total fee (37 CFR 3.41)....\$ **40.00**
☐ Enclosed
☒ Authorized to be charged to
deposit account

8. Deposit Account Number: **50-2587**

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

February 27, 2006
Date


JOHN L. ROGITZ

Total number of pages including cover sheet, attachments, and document: 2

700246506

PATENT
REEL: 017295 FRAME: 0665

CH \$40.00 502587 11329930

DOCKET NO.: HSJ920050087US1

ASSIGNMENT

INVENTOR
AND CITY

Whereas, We,
(1) Timothy Clark Reiley of San Jose, California; and
(2) Nicholas Buchan of San Jose, California.

TITLE

have invented certain improvements in

POST-PARTING ETCH TO SMOOTH SILICON SLIDERS

DATES THAT
INVENTORS
SIGNED THE

and executed, respectively, a United States patent application therefore on

(1) Oct. 4, 2005 (2) _____

Whereas, HITACHI GLOBAL STORAGE TECHNOLOGIES NETHERLANDS B.V., having a place of business at Locatellikade 1, 1076 AZ Amsterdam, The Netherlands (hereinafter called HITACHI), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to HITACHI, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HITACHI, its successors and assigns; and we hereby agree that HITACHI may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HITACHI.

Signed

CITY
DATE

(1) at San Jose
on Oct. 4, 2005.

Timothy Clark Reiley SIGNATURE
TIMOTHY CLARK REILEY

CITY
DATE

(2) at _____
on _____, 2005.

NICHOLAS BUCHAN SIGNATURE
INVENTOR

DOCKET NO.: HSJ920050087US1

ASSIGNMENTINVENTOR
AND CITY

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- (1) _____ (2) 10/10/05

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Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to HITACHI, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HITACHI, its successors and assigns; and we hereby agree that HITACHI may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HITACHI.

Signed

CITY

(1) at _____

DATE

on _____, 2005.

TIMOTHY CLARK REILEY SIGNATURE

CITY

(2) at San Jose

DATE

on 10/10, 2005.

Nicholas E. Buchan
 NICHOLAS BUCHAN SIGNATURE
 INVENTOR

PATENT

RECORDED: 02/27/2006

REEL: 017295 FRAME: 0667